

**N-Ch MOSFET** 

# **General Description**

The WSF60120 is the highest performance SGT N-Ch MOSFET with extreme high cell density , which provide excellent RDSON and gate charge for most of the synchronous buck converter applications .

The WSF60120 meet the RoHS and Green Product requirement, 100% EAS guaranteed with full function reliability approved.

#### **Features**

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- 100% EAS Guaranteed
- Green Device Available

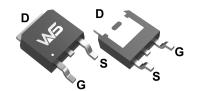
# **Product Summery**

BVDSS	RDSON	ID
60V	$3.0 m\Omega$	110A

## **Applications**

- High Frequency Point-of-Load Synchronous Buck Converter for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- LCD/LED back light

# **TO-252 Pin Configuration**





## **Absolute Maximum Ratings**

Symbol	Parameter	Rating	Units
V <sub>DS</sub>	Drain-Source Voltage	60	V
$V_{GS}$	Gate-Source Voltage	±20	V
I <sub>D</sub> @T <sub>C</sub> =25°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	110	Α
I <sub>D</sub> @T <sub>C</sub> =100℃	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	66	Α
I <sub>DM</sub>	Pulsed Drain Current <sup>2</sup>	240	Α
EAS	Single Pulse Avalanche Energy <sup>3</sup>	101	mJ
I <sub>AS</sub>	Avalanche Current	45	Α
P <sub>D</sub> @T <sub>C</sub> =25°C	Total Power Dissipation⁴	83	W
P <sub>D</sub> @T <sub>A</sub> =25℃	Total Power Dissipation⁴	2.5	W
T <sub>STG</sub>	Storage Temperature Range	-55 to 175	°C
TJ	Operating Junction Temperature Range	-55 to 175	$^{\circ}$

#### **Thermal Data**

Symbol	Parameter	Тур.	Max.	Unit
R <sub>0JA</sub>	Thermal Resistance Junction-Ambient <sup>1</sup>		55	°C/W
$R_{ heta JC}$	Thermal Resistance Junction-Case <sup>1</sup>		1.5	°C/W

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# Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =250uA	60			V
$\triangle BV_{DSS}/\triangle T_{J}$	BV <sub>DSS</sub> Temperature Coefficient	Reference to 25°C , I <sub>D</sub> =1mA		0.057		V/°C
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =10V , I <sub>D</sub> =20A		3.0	3.6	mΩ
		V <sub>GS</sub> =4.5V , I <sub>D</sub> =15A.		4.4	5.4	
$V_{GS(th)}$	Gate Threshold Voltage	\/ -\/   -250uA	1.2		2.3	V
$\triangle V_{GS(th)}$	V <sub>GS(th)</sub> Temperature Coefficient	$V_{GS}=V_{DS}$ , $I_D=250uA$		-5.68		mV/℃
	Drain-Source Leakage Current	$V_{DS}$ =48V , $V_{GS}$ =0V , $T_J$ =25 $^{\circ}$ C			1	
I <sub>DSS</sub>				5	· uA	
I <sub>GSS</sub>	Gate-Source Leakage Current	V <sub>GS</sub> =±20V , V <sub>DS</sub> =0V			±100	nA
gfs	Forward Transconductance	V <sub>DS</sub> =5V , I <sub>D</sub> =20A		65		S
Rg	Gate Resistance	V <sub>DS</sub> =0V , V <sub>GS</sub> =0V , f=1MHz		0.7	1.0	Ω
$Q_{g}$	Total Gate Charge (4.5V)	V <sub>DS</sub> =30V , V <sub>GS</sub> =4.5V , I <sub>D</sub> =20A		58		
$Q_gs$	Gate-Source Charge			16		nC
$Q_{gd}$	Gate-Drain Charge			4		
T <sub>d(on)</sub>	Turn-On Delay Time	$V_{DD}$ =30V , $V_{GS}$ =10V , $R_{G}$ =3 $\Omega$ , RL=1.5 $\Omega$ .		18		
T <sub>r</sub>	Rise Time			8		
T <sub>d(off)</sub>	Turn-Off Delay Time			50		ns
T <sub>f</sub>	Fall Time			10.5		
Ciss	Input Capacitance	V <sub>DS</sub> =30V , V <sub>GS</sub> =0V , f=1MHz		3458		
C <sub>oss</sub>	Output Capacitance			1522		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			22		

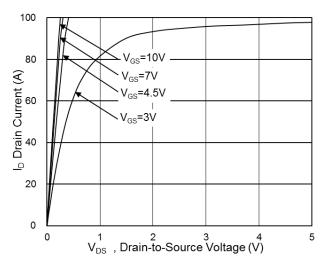
## **Diode Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
I <sub>S</sub>	Continuous Source Current <sup>1,6</sup>	V <sub>G</sub> =V <sub>D</sub> =0V , Force Current			55	Α
$V_{SD}$	Diode Forward Voltage <sup>2</sup>	V <sub>GS</sub> =0V , I <sub>S</sub> =1A , T <sub>J</sub> =25℃			1.3	V
t <sub>rr</sub>	Reverse Recovery Time			24		nS
Qrr	Reverse Recovery Charge	∏F=20A ,dI/dt=100A/μs,Tյ=25℃		85		nC

- 1.The data tested by surface mounted on a 1 inch2 FR-4 board with 2OZ copper,t<10sec. 2.The data tested by pulsed , pulse width  $\leq$  300us , duty cycle  $\leq$  2%
- 3. The EAS data shows Max. rating . The test condition is  $V_{DD}$ =25V, $V_{GS}$ =10V,L=0.1mH,I<sub>AS</sub>=60A
- 5.The Min. value is 100% EAS tested guarantee.
- 6. The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications, should be limited by total power dissipation.



# **Typical Characteristics**



**Fig.1 Typical Output Characteristics** 

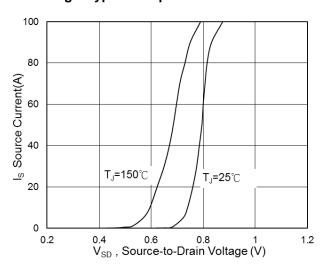


Fig.3 Diode Forward Voltage vs. Current

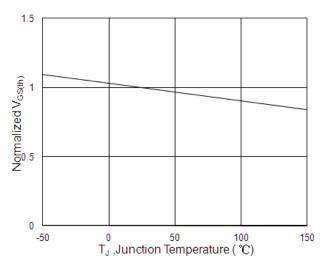


Fig.5 Normalized  $V_{GS(th)}$  vs  $T_J$ 

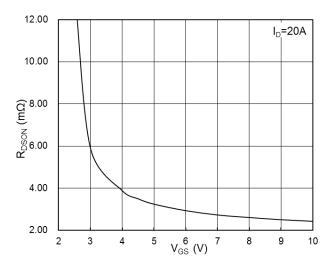


Fig.2 On-Resistance vs G-S Voltage

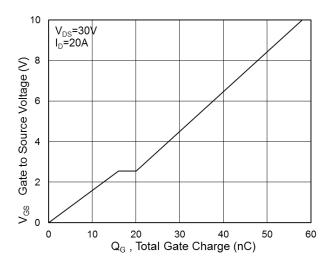


Fig.4 Gate-Charge Characteristics

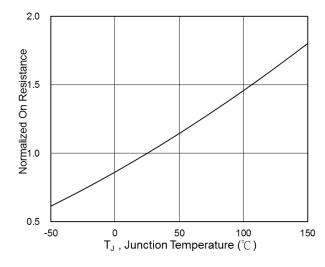
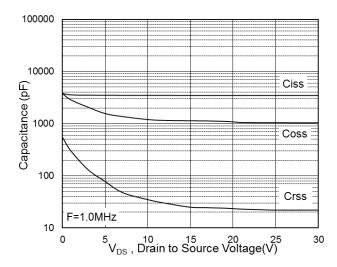


Fig.6 Normalized R<sub>DSON</sub> vs T<sub>J</sub>





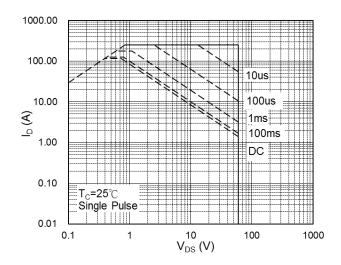


Fig.7 Capacitance

Fig.8 Safe Operating Area

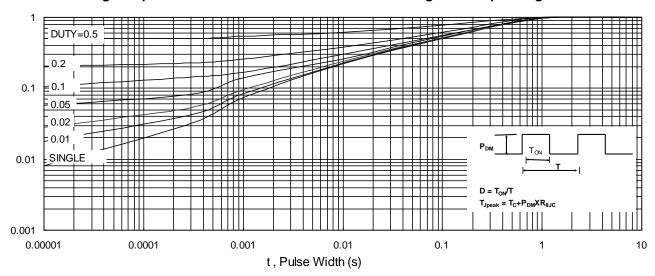


Fig.9 Normalized Maximum Transient Thermal Impedance

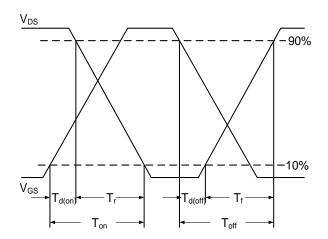


Fig.10 Switching Time Waveform

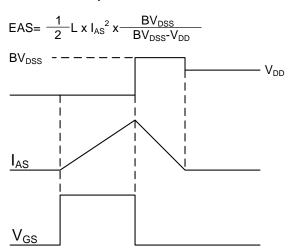


Fig.11 Unclamped Inductive Switching Waveform



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